

TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

**TD62001P,TD62001AP,TD62001F,TD62001AF,TD62002P
TD62002AP,TD62002F,TD62002AF,TD62003P,TD62003AP,TD62003F
TD62003AF,TD62004P,TD62004AP,TD62004F,TD62004AF**

7CH DARLINGTON SINK DRIVER

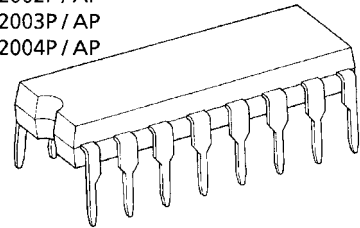
The TD62001P / AP / F / AF Series are high-voltage, high-current darlington drivers comprised of seven NPN darlington pairs. All units feature integral clamp diodes for switching inductive loads. Applications include relay, hammer, lamp and display (LED) drivers.

FEATURES

- Output current (single output) 500 mA MAX.
- High sustaining voltage output
35 V MIN. (TD62001P / F Series)
50 V MIN. (TD62001AP / AF Series)
- Output clamp diodes
- Inputs compatible with various types of logic
- Package Type-P, AP: DIP-16 pin
- Package Type-F, AF: SOP-16 pin

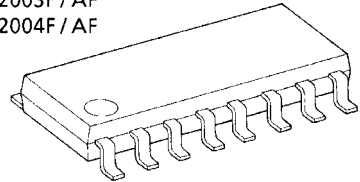
TYPE	INPUT BASE RESISTOR	DESIGNATION
TD62001P / AP / F / AF	External	General Purpose
TD62002P / AP / F / AF	10.5-k Ω + 7 V Zener diode	14~25 V PMOS
TD62003P / AP / F / AF	2.7 k Ω	TTL, 5 V CMOS
TD62004P / AP / F / AF	10.5 k Ω	6~15 V PMOS, CMOS

TD62001P / AP
TD62002P / AP
TD62003P / AP
TD62004P / AP



DIP16-P-300-2.54A

TD62001F / AF
TD62002F / AF
TD62003F / AF
TD62004F / AF



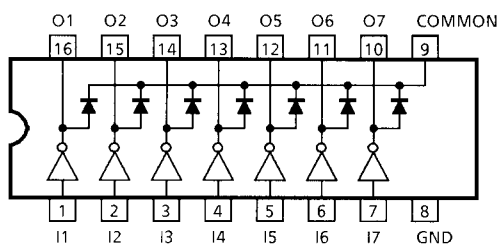
SOP16-P-225-1.27

Weight

DIP16-P-300-2.54A : 1.11 g (Typ.)

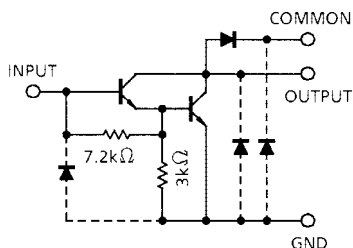
SOP16-P-225-1.27 : 0.16 g (Typ.)

PIN CONNECTION (TOP VIEW)

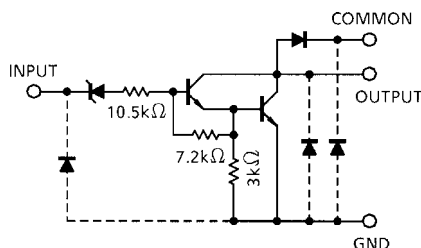


SCHEMATICS (EACH DRIVER)

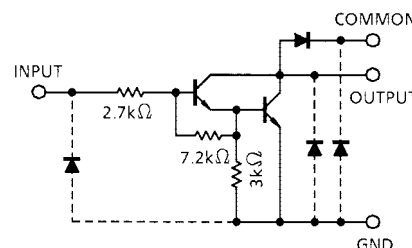
TD62001P / AP / F / AF



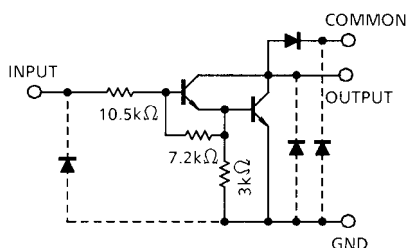
TD62002P / AP / F / AF



TD62003P / AP / F / AF



TD62004P / AP / F / AF



Note: The input and output parasitic diodes cannot be used as clamp diodes.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Output Sustaining Voltage	P, F	$V_{CE(SUS)}$	-0.5~35	V
	AP, AF		-0.5~50	
Output Current		I_{OUT}	500	mA / ch
Input Voltage		V_{IN} (Note 1)	-0.5~30	V
Input Current		I_{IN} (Note 2)	25	mA
Clamp Diode Reverse Voltage	P, F	V_R	35	V
	AP, AF		50	
Clamp Diode Forward Current		I_F	500	mA
Power Dissipation	P	P_D	1.0	W
	AP		1.47	
	F, AF		0.54 / 0.625 (Note 3)	
Operating Temperature	P	T_{opr}	-30~75	°C
	AP, F, AF		-40~85	
Storage Temperature		T_{stg}	-55~150	°C

Note 1: Except TD62001P / AP / F / AF

Note 2: Only TD62001P / AP / F / AF

Note 3: On glass epoxy PCB (30 × 30 × 1.6 mm Cu 50%)

RECOMMENDED OPERATING CONDITIONS

(Ta = -40~85°C and Ta = -30~75°C for only Type-P)

CHARACTERISTIC		SYMBOL	CONDITION		MIN	TYP.	MAX	UNIT
Output Sustaining Voltage	P, F	V _{CE (SUS)}			0	—	35	V
	AP, AF				0	—	50	
Output Current	AP	I _{OUT}	T _{pw} = 25 ms 7 Circuits Ta = 85°C Tj = 120°C	Duty = 10%	0	—	370	mA / ch
				Duty = 50%	0	—	130	
	P			Duty = 10%	0	—	295	
				Duty = 50%	0	—	95	
	F, AF			Duty = 10%	0	—	233	
				Duty = 50%	0	—	70	
Input Voltage	Except TD62001P / AP / F / AF	V _{IN}			0	—	24	V
Input Voltage (Output On)	TD62002	V _{IN (ON)}	I _{OUT} = 400 mA h _{FE} = 800		14.5	—	24	V
	TD62003				2.8	—	24	
	TD62004				6.2	—	24	
Input Voltage (Output Off)	TD62001	V _{IN (OFF)}			0	—	0.6	V
	TD62002				0	—	7.4	
	TD62003				0	—	0.7	
	TD62004				0	—	1.0	
Input Current	Only TD62001	I _{IN}			0	—	10	mA
Clamp Diode Reverse Voltage	P, F	V _R			—	—	35	V
	AP, AF				—	—	50	
Clamp Diode Forward Current		I _F			—	—	350	mA
Power Dissipation	P	P _D	Ta = 85°C		—	—	0.6	W
	AP				—	—	0.76	
	AF, F		Ta = 85°C (Note)		—	—	0.325	

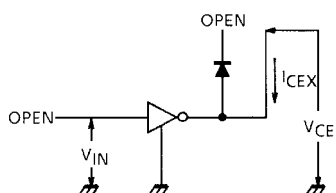
Note: On glass epoxy PCB (30 × 30 × 1.6 mm Cu 50%)

ELECTRICAL CHARACTERISTICS (Ta = 25°C unless otherwise noted)

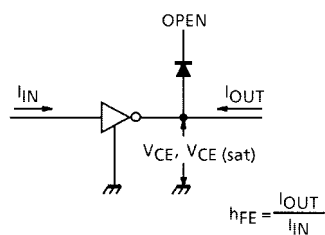
CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION		MIN	TYP.	MAX	UNIT			
Output Leakage Current	AP, AF	I _{CEX}	1	V _{CE} = 50 V, Ta = 25°C		—	—	50	μA			
	V _{CE} = 50 V, Ta = 85°C			—	—	100						
	F			V _{CE} = 35 V, Ta = 25°C		—	—	50				
				V _{CE} = 35 V, Ta = 85°C		—	—	100				
	P			V _{CE} = 35 V, Ta = 25°C		—	—	50				
				V _{CE} = 35 V, Ta = 75°C		—	—	100				
Collector–Emitter Saturation Voltage		V _{CE (sat)}	2	I _{OUT} = 350 mA, I _{IN} = 500 μA		—	1.3	1.6	V			
				I _{OUT} = 200 mA, I _{IN} = 350 μA		—	1.1	1.3				
				I _{OUT} = 100 mA, I _{IN} = 250 μA		—	0.9	1.1				
DC Current Transfer Ratio		h _{FE}	2	V _{CE} = 2 V, I _{OUT} = 350 mA		1000	—	—				
Input Current (Output On)	TD62002	I _{IN (ON)}	3	V _{IN} = 20 V, I _{OUT} = 350 mA		—	1.1	1.7	mA			
	TD62003			V _{IN} = 2.4 V, I _{OUT} = 350 mA		—	0.4	0.7				
	TD62004			V _{IN} = 9.5 V, I _{OUT} = 350 mA		—	0.8	1.2				
Input Current (Output Off)	P	I _{IN (OFF)}	4	I _{OUT} = 500 μA, Ta = 75°C		50	65	—	μA			
	AP, F, AF			I _{OUT} = 500 μA, Ta = 85°C		50	65	—				
Input Voltage (Output On)	TD62002	V _{IN (ON)}	5	V _{CE} = 2 V h _{FE} = 800	I _{OUT} = 350 mA	—	—	13.7	V			
	I _{OUT} = 200 mA				—	—	11.4					
	TD62003				I _{OUT} = 350 mA					—	—	2.6
					I _{OUT} = 200 mA					—	—	2.0
	TD62004				I _{OUT} = 350 mA					—	—	4.7
					I _{OUT} = 200 mA					—	—	4.4
Clamp Diode Reverse Current	AP, AF	I _R	6	V _R = 50 V, Ta = 25°C		—	—	50	μA			
	V _R = 50 V, Ta = 85°C			—	—	100						
	F			V _R = 35 V, Ta = 25°C		—	—	50				
				V _R = 35 V, Ta = 85°C		—	—	100				
	P			V _R = 35 V, Ta = 25°C		—	—	50				
				V _R = 35 V, Ta = 75°C		—	—	100				
Clamp Diode Forward Voltage		V _F	7	I _F = 350 mA		—	—	2.0	V			
Input Capacitance		C _{IN}	—			—	15	—	pF			
Turn-On Delay	P, F	t _{ON}	8	V _{OUT} = 35 V, R _L = 87.5 Ω C _L = 15 pF		—	0.1	—	μs			
	AP, AF			V _{OUT} = 50 V, R _L = 125 Ω C _L = 15 pF		—	0.1	—				
Turn-Off Delay	P, F	t _{OFF}	8	V _{OUT} = 35 V, R _L = 87.5 Ω C _L = 15 pF		—	0.2	—				
	AP, AF			V _{OUT} = 50 V, R _L = 125 Ω C _L = 15 pF		—	0.2	—				

TEST CIRCUIT

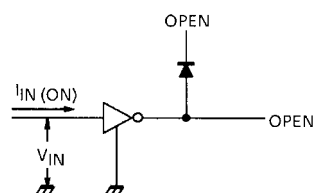
1. I_{CEX}



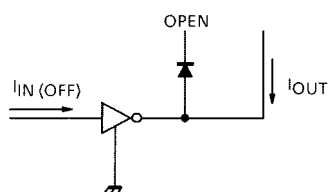
2. $V_{CE} (sat)$, h_{FE}



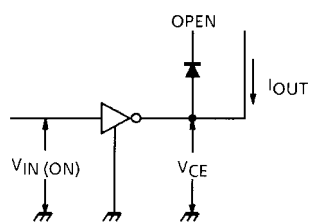
3. $I_{IN} (ON)$



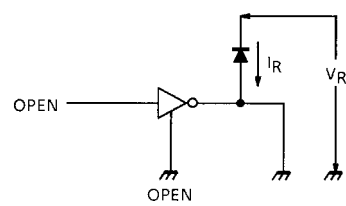
4. $I_{IN} (OFF)$



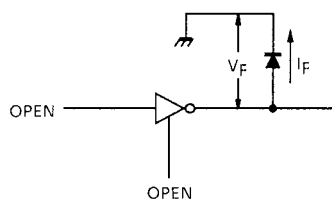
5. $V_{IN} (ON)$



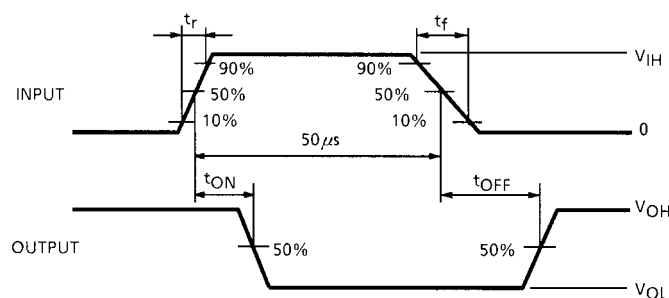
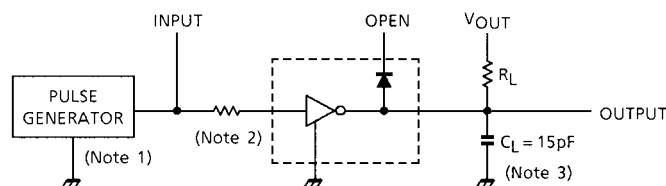
6. I_R



7. V_F



8. t_{ON} , t_{OFF}



Note 1: Pulse width 50 μ s, duty cycle 10%
Output impedance 50 Ω , $t_r \leq 5$ ns, $t_f \leq 10$ ns

Note 2: See below

INPUT CONDITION

TYPE NUMBER	R1	V_{IH}
TD62001P / AP / F / AF	2.7 k Ω	3 V
TD62002P / AP / F / AF	0	13 V
TD62003P / AP / F / AF	0	3 V
TD62004P / AP / F / AF	0	8 V

Note 3: C_L includes probe and jig capacitance.

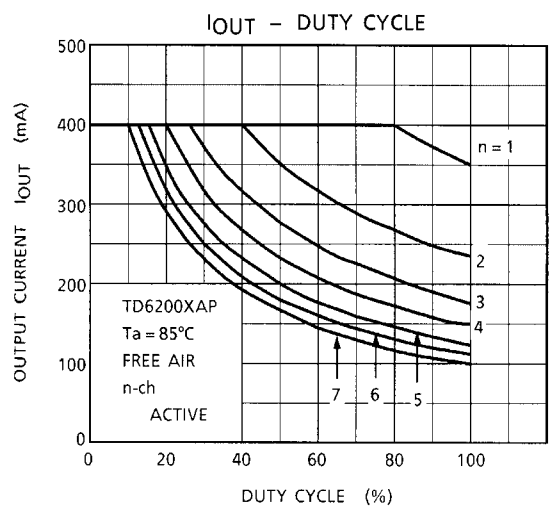
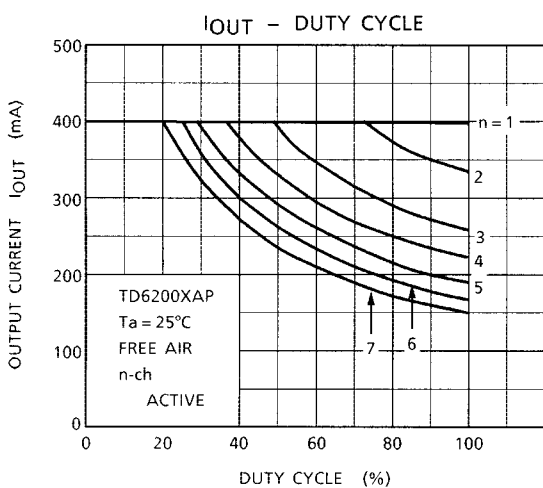
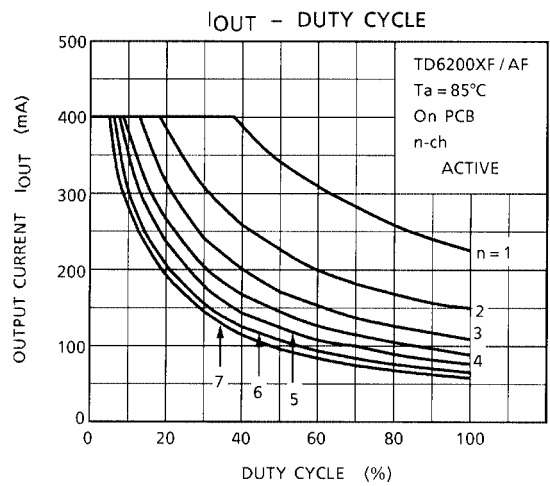
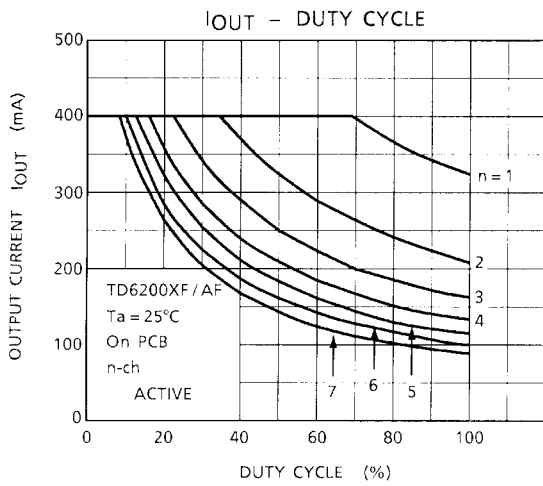
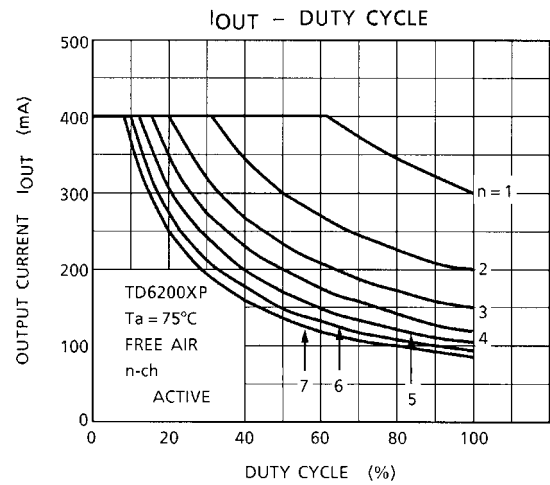
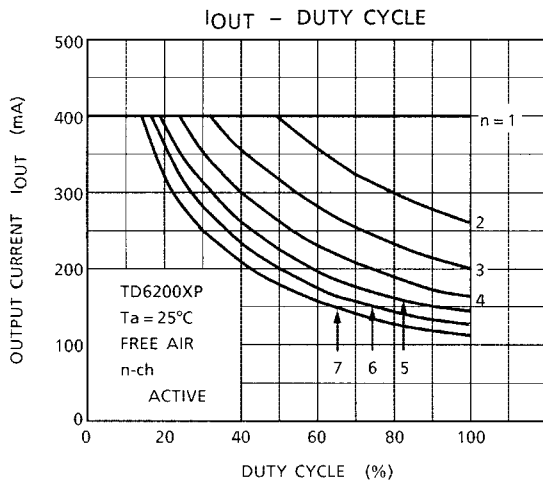
PRECAUTIONS for USING

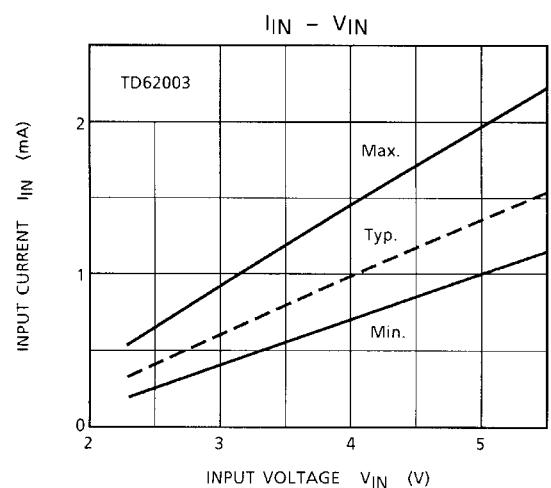
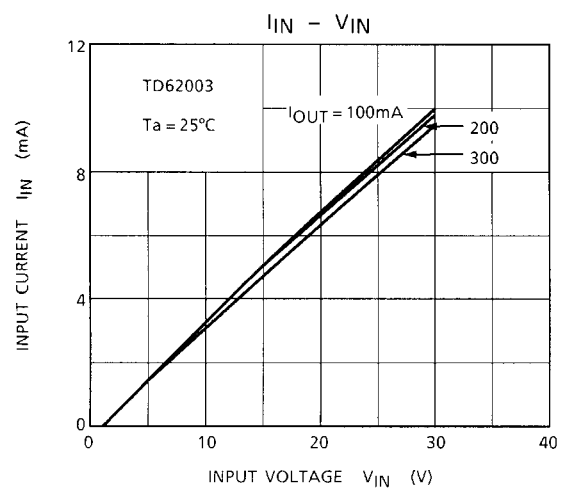
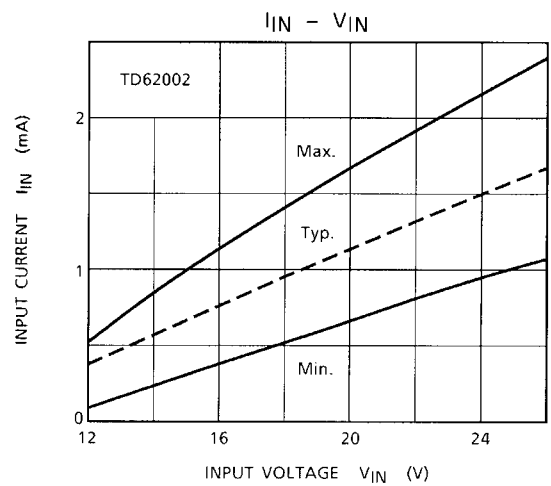
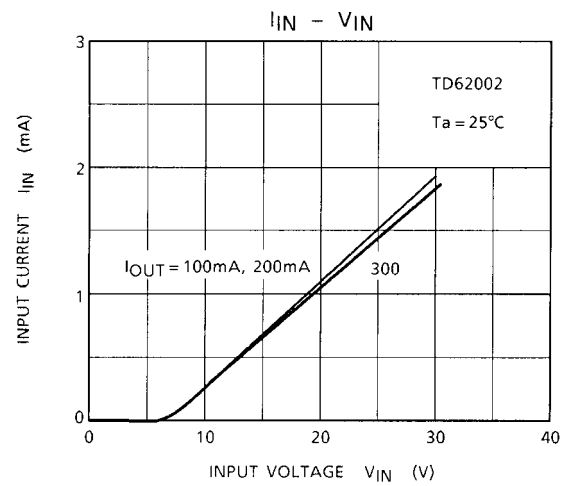
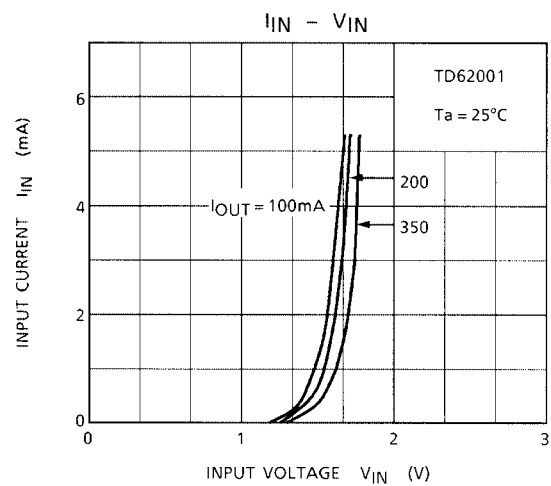
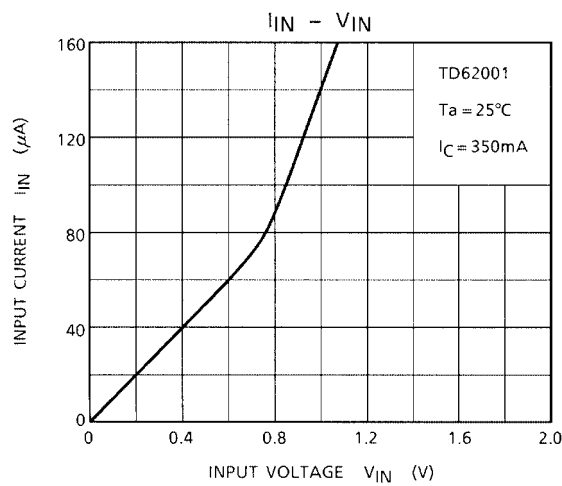
This IC does not include built-in protection circuits for excess current or overvoltage.

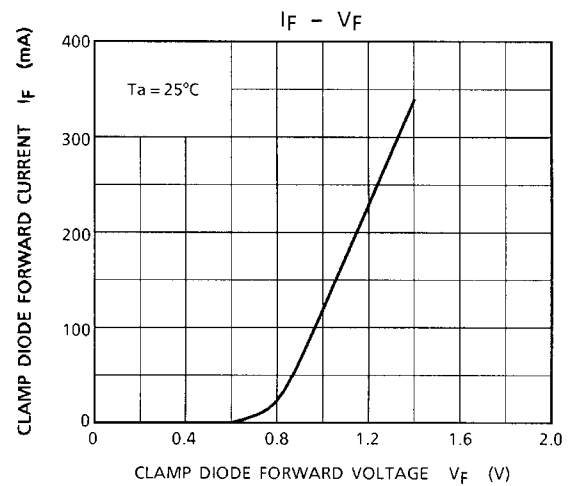
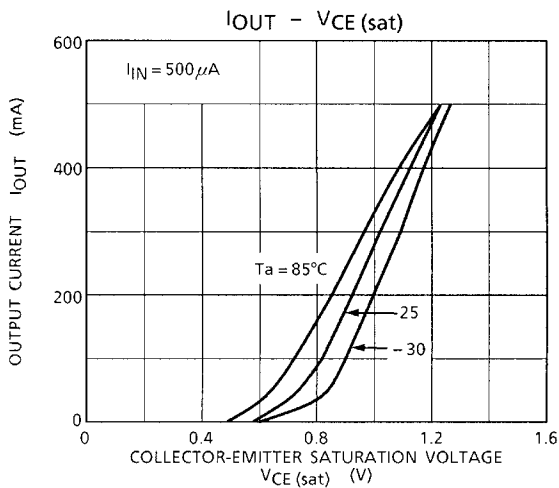
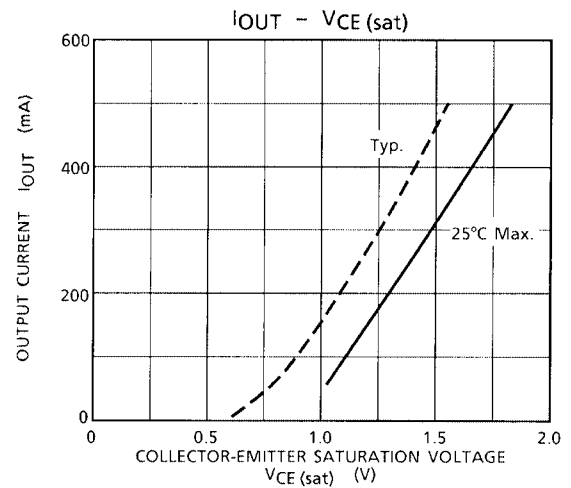
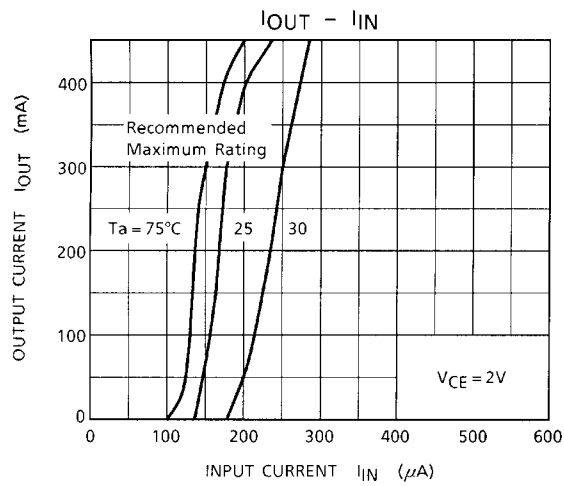
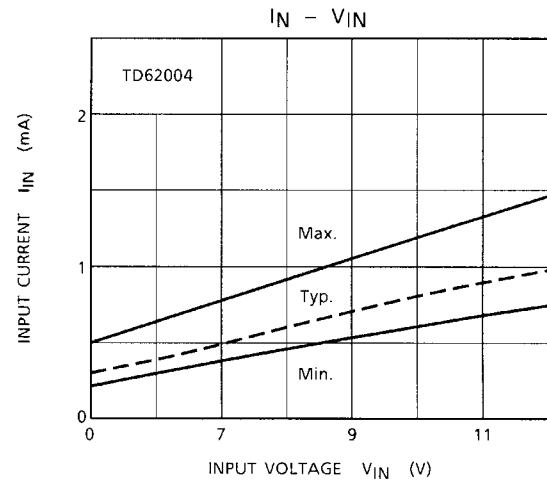
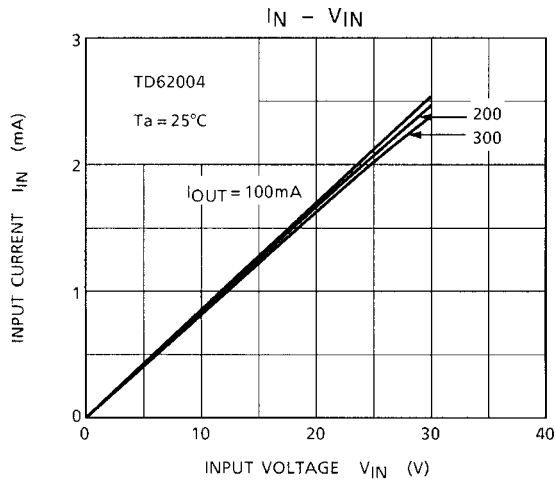
If this IC is subjected to excess current or overvoltage, it may be destroyed.

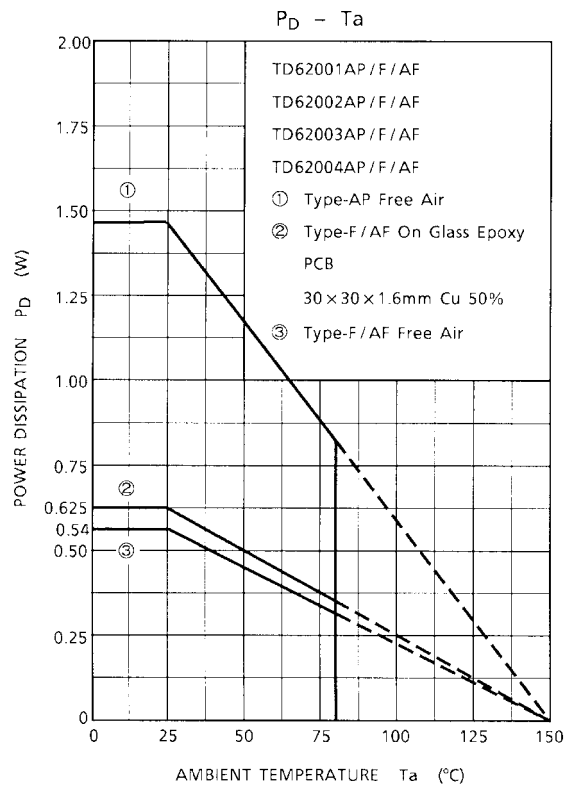
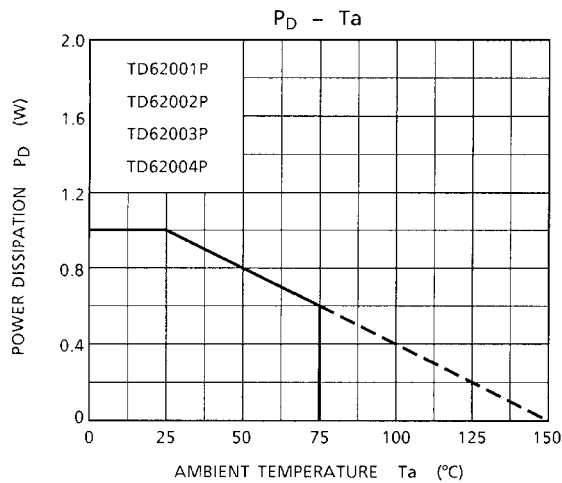
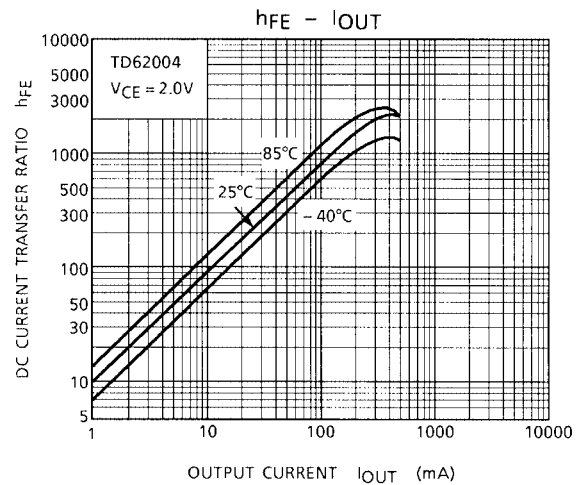
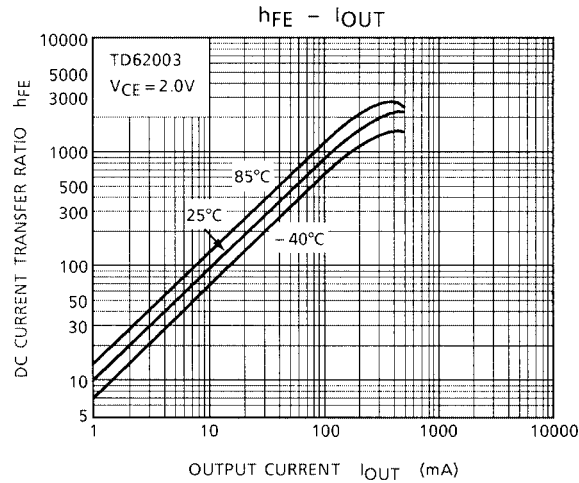
Hence, the utmost care must be taken when systems which incorporate this IC are designed.

Utmost care is necessary in the design of the output line, COMMON and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.





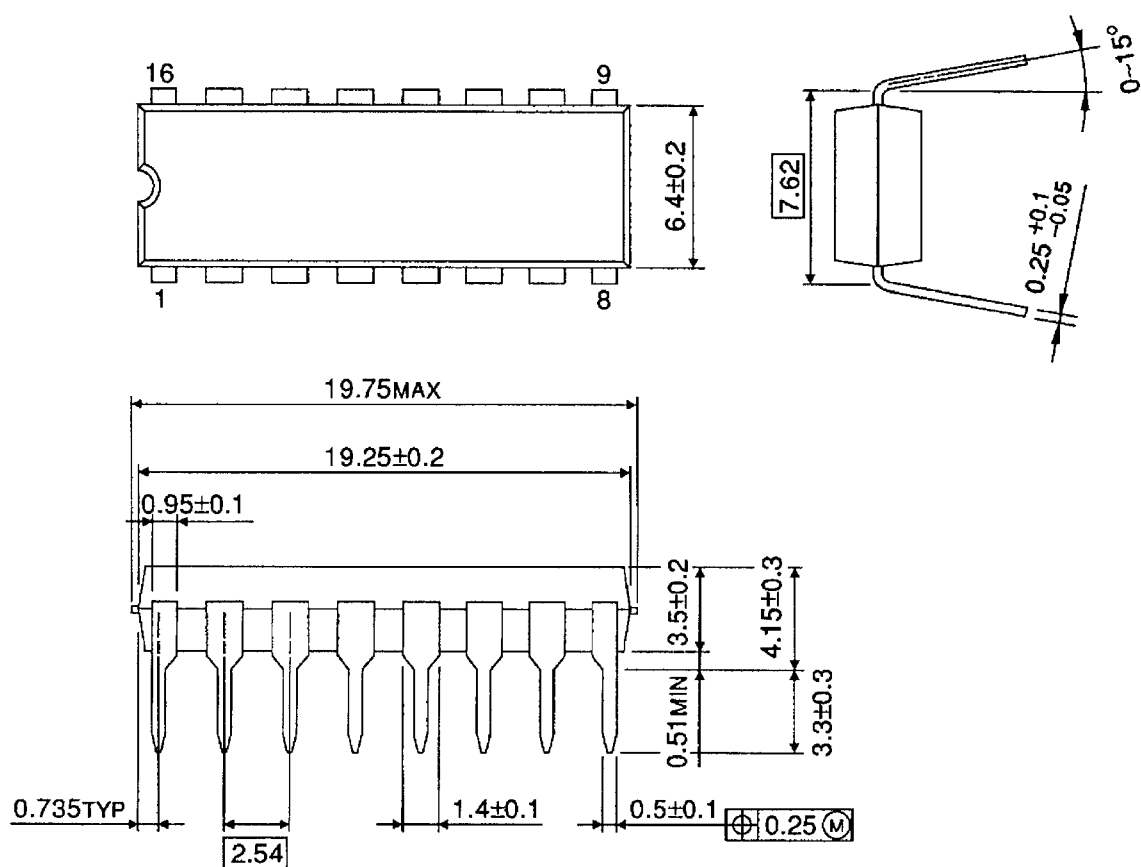




PACKAGE DIMENSIONS

DIP16-P-300-2.54A

Unit : mm

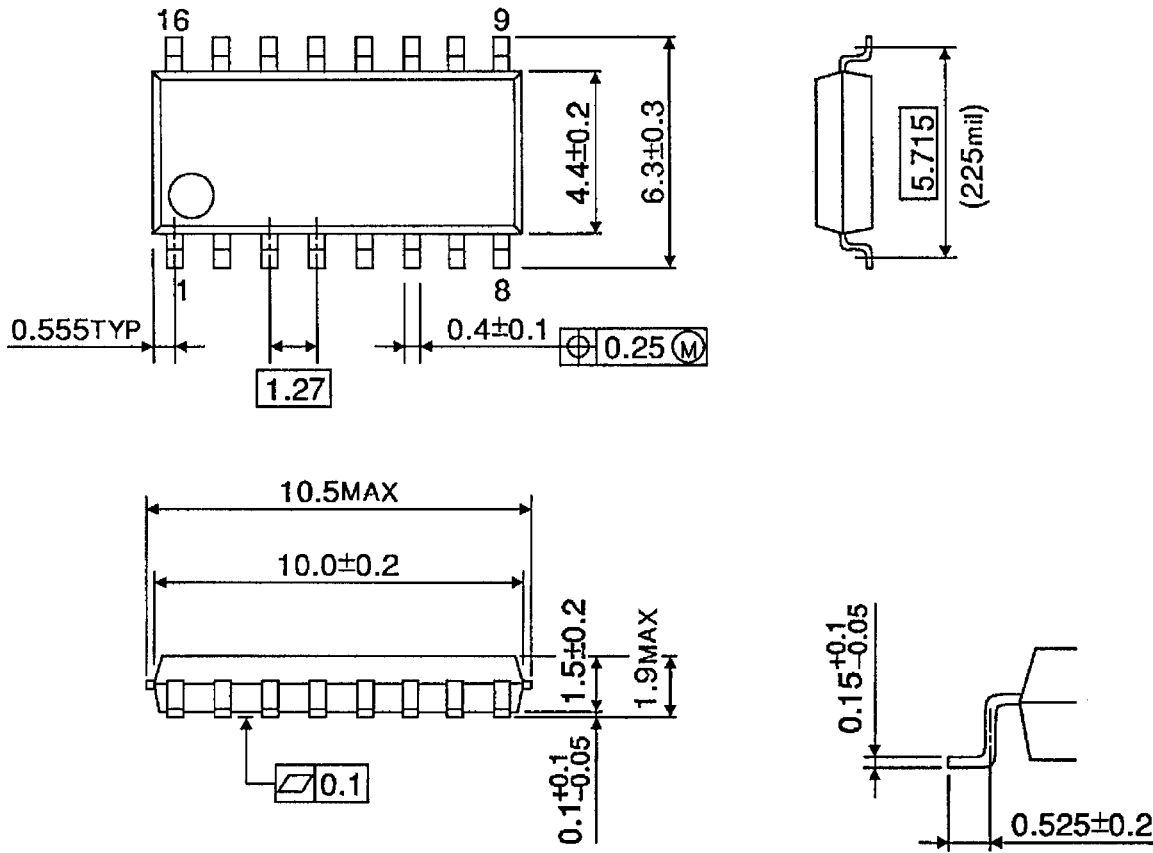


Weight: 1.11 g (Typ.)

PACKAGE DIMENSIONS

SOP16-P-225-1.27

Unit : mm



Weight: 0.16 g (Typ.)

RESTRICTIONS ON PRODUCT USE

000707EBA

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In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
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